

Features

- · Split Gate Trench MOSFET Technology
- · Low Thermal Resistance
- · Moisture Senstivity Level 3
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

Operating Junction Temperature Range : -55°C to +150°C

• Storage Temperature Range: -55°C to +150°C

• Thermal Resistance: 50°C/W Junction to Ambient(Note 2)

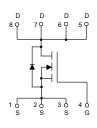
Thermal Resistance: 1.08°C/W Junction to Case

Parameter		Symbol	Rating	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Volltage		V_{GS}	±20	V	
Continuous Drain Current	T _C =25°C	I _D	120	Α	
	T _C =100°C		75		
Pulsed Drain Current ^(Note 3)		I _{DM}	480	Α	
Total Power Dissipation(Note 4)		P _D	116	W	
Single Pulsed Avalanche Energy ^(Note 5)		E _{AS}	529	mJ	

Note:

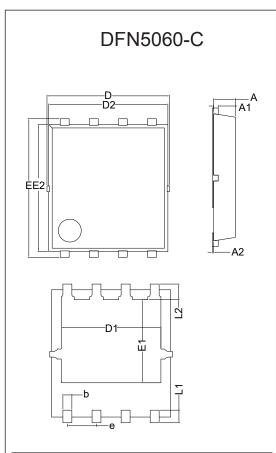
- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. The value of R θ JA is measured with the device mounted on 1 in 2 FR-4 board with 2oz. copper, in a still air environment with TJ=25°C.
- 3. Repetitive rating; pulse width limited by max. junction temperature.
- 4. P_D is based on max. junction temperature, using junction-case thermal resistance.
- 5. V_{DD} =50V, R_{G} =25 Ω , V_{G} =10V,L=2mH.

Internal Structure and Marking Code





N-CHANNEL MOSFET



DIMENSIONS					
DIM	INCHES		M	NOTE	
	MIN	MAX	MIN	MAX	NOTE
D	0.203	0.218	5.15	5.55	
D2	0.201	0.209	5.10	5.30	
E	0.234	0.242	5.95	6.15	
E2	0.215	0.222	5.45	5.65	
Α	0.033	0.041	0.85	1.05	
A1	0.008		0.203		BSC
A2	0.000	0.004	0.00	0.10	
D1	0.167	0.175	4.25	4.45	
E1	0.139	0.147	3.52	3.73	
L1	0.018	0.026	0.45	0.65	
L2	0.027		0.68		BSC
b	0.012	0.020	0.30	0.50	
е	0.050		1.27		BSC

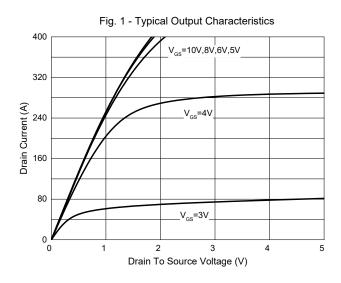


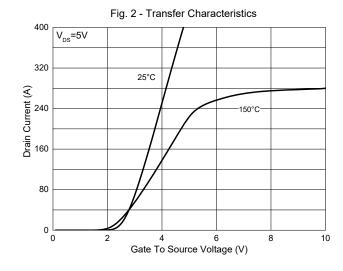
Electrical Characteristics @ 25°C (Unless Otherwise Specified)

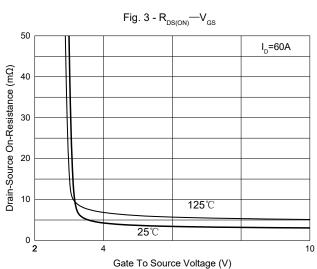
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static Characteristics				1	I		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	100			V	
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V			1	μΑ	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0	1.8	2.5	V	
Drain-Source On-Resistance		V _{GS} =10V, I _D =20A		3.2	4.0	mΩ	
	$R_{DS(on)}$	V _{GS} =4.5V, I _D =20A		4.0	5.0 mΩ		
Gate Resistance	R _g	f=1MHz, Open drain		0.9		Ω	
Diode Characteristics							
Continuous Body Diode Current	Is				120	А	
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =20A		0.9	1.2	V	
Reverse Recovery Time	t _{rr}	L 004 H / H 4004 /		50		ns	
Reverse Recovery Charge	Q _{rr}	I _F =60A, dI _F /dt=100A/μs		51		nC	
Dynamic Characteristics							
Input Capacitance	C _{iss}			4400			
Output Capacitance	C _{oss}	V_{DS} =50V, V_{GS} =0V,f=1MHz		1600		pF	
Reverse Transfer Capacitance	C _{rss}			30			
Total Gate Charge	Qg			75			
Gate-Source Charge	Q_{gs}	V _{DS} =50V,V _{GS} =10V,I _D =60A		18		nC	
Gate-Drain Charge	Q_{gd}			12			
Turn-On Delay Time	t _{d(on)}			18			
Turn-On Rise Time	t _r	V _{DS} =50V, V _{GEN} =10V,		14			
Turn-Off Delay Time	t _{d(off)}	$R_G=3\Omega$, $I_{DS}=60A$		58		- ns	
Turn-Off Fall Time	t _f			19			

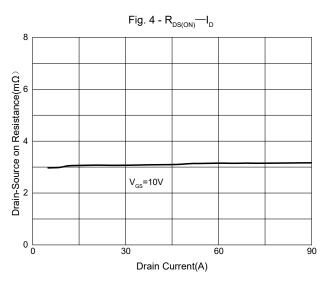


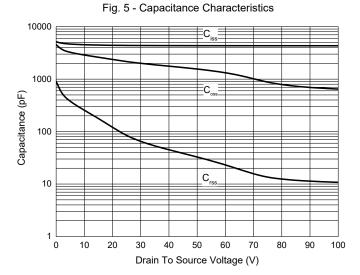
Curve Characteristics

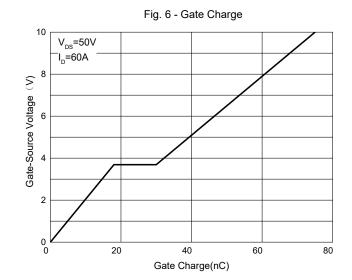






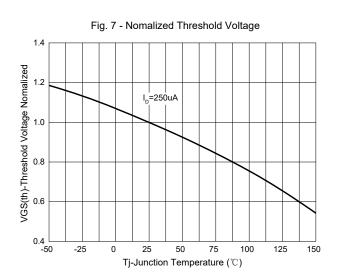


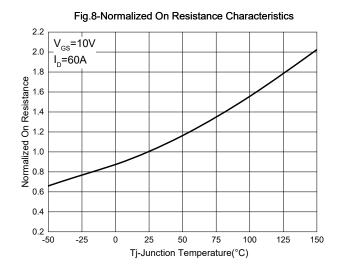


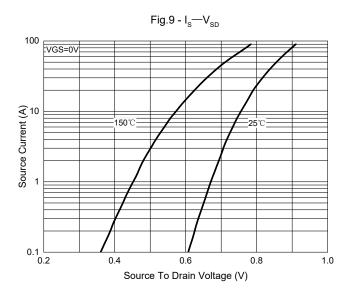


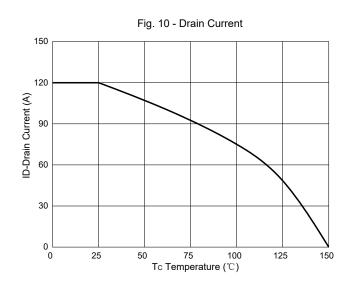


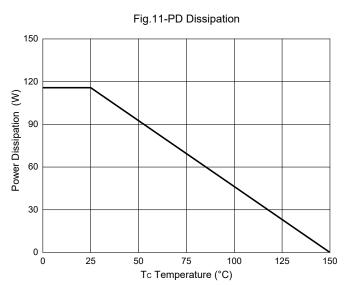
Curve Characteristics













Curve Characteristics

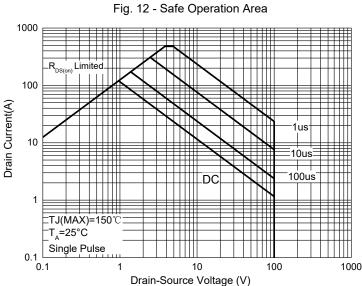


Fig. 13 -Normalized Transient Thermal Impedance

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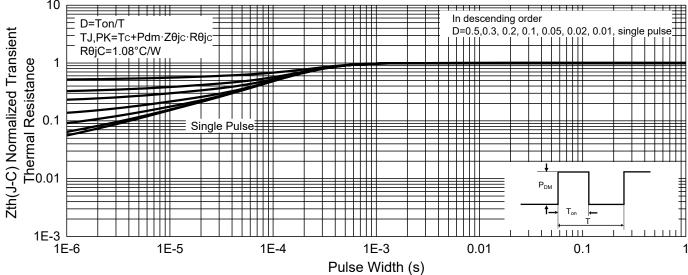
T_A=25°C
Single Pulse

Drain-Source Voltage (V)

Fig. 13 -Normalized Transient Thermal Impedance

T_D=Ton/T
TJ,PK=Tc+Pdm·Zθjc·Rθjc
RθjC=1.08°C/W

RθjC=1.08°C/W





Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 5Kpcs/Reel

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